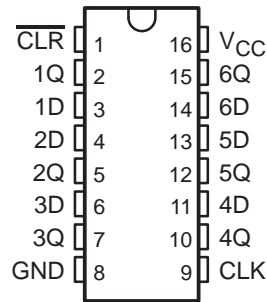


SN54AHC174, SN74AHC174 HEX D-TYPE FLIP-FLOPS WITH CLEAR

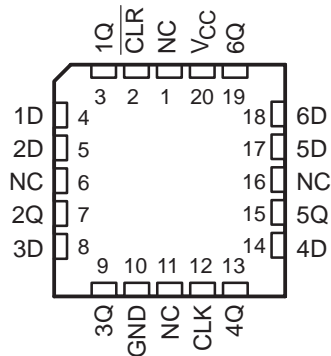
SCLS425E – JUNE 1998 – REVISED JANUARY 2000

- **EPIC™ (Enhanced-Performance Implanted CMOS) Process**
- **Operating Range 2-V to 5.5-V V_{CC}**
- **Contain Six Flip-Flops With Single-Rail Outputs**
- **Applications Include:**
 - Buffer/Storage Registers
 - Shift Registers
 - Pattern Generators
- **Latch-Up Performance Exceeds 250 mA Per JESD 17**
- **ESD Protection Exceeds JESD 22**
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)
- **Package Options Include Plastic Small-Outline (D), Shrink Small-Outline (DB), Thin Very Small-Outline (DGV), Thin Shrink Small-Outline (PW), and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) DIPs**

SN54AHC174 . . . J OR W PACKAGE
SN74AHC174 . . . D, DB, DGV, N, OR PW PACKAGE
(TOP VIEW)



SN54AHC174 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

description

The 'AHC174 devices are positive-edge-triggered D-type flip-flops with a direct clear ($\overline{\text{CLR}}$) input and are designed for 2-V to 5.5-V V_{CC} operation.

Information at the data (D) inputs that meets the setup time requirements is transferred to the outputs on the positive-going edge of the clock (CLK) pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going edge of CLK. When CLK is at either the high or low level, the D input has no effect at the output.

The SN54AHC174 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74AHC174 is characterized for operation from -40°C to 85°C .

FUNCTION TABLE
(each flip-flop)

INPUTS			OUTPUT
$\overline{\text{CLR}}$	CLK	D	Q
L	X	X	L
H	\uparrow	H	H
H	\uparrow	L	L
H	L	X	Q_0



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

EPIC is a trademark of Texas Instruments Incorporated.

UNLESS OTHERWISE NOTED this document contains PRODUCTION DATA information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS
INSTRUMENTS**

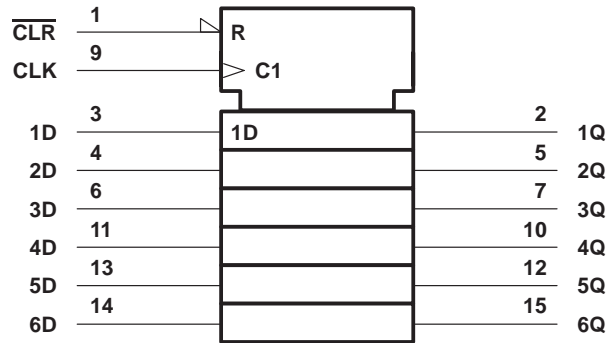
POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 2000, Texas Instruments Incorporated

SN54AHC174, SN74AHC174 HEX D-TYPE FLIP-FLOPS WITH CLEAR

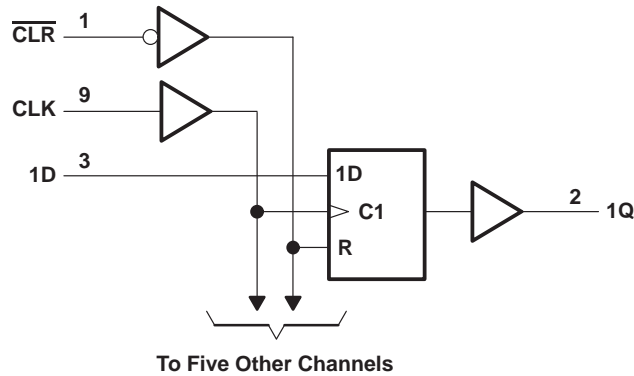
SCLS425E – JUNE 1998 – REVISED JANUARY 2000

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, DB, DGV, J, N, PW, and W packages.

logic diagram (positive logic)



Pin numbers shown are for the D, DB, DGV, J, N, PW, and W packages.

SN54AHC174, SN74AHC174 HEX D-TYPE FLIP-FLOPS WITH CLEAR

SCLS425E – JUNE 1998 – REVISED JANUARY 2000

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	–0.5 V to 7 V
Input voltage range, V_I (see Note 1)	–0.5 V to 7 V
Output voltage range, V_O (see Note 1)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	–20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±25 mA
Continuous current through V_{CC} or GND	±50 mA
Package thermal impedance, θ_{JA} (see Note 2):	
D package	73°C/W
DB package	82°C/W
DGV package	120°C/W
N package	67°C/W
PW package	108°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 3)

		SN54AHC174		SN74AHC174		UNIT
		MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage	2	5.5	2	5.5	V
V_{IH}	High-level input voltage	$V_{CC} = 2$ V	1.5	1.5		V
		$V_{CC} = 3$ V	2.1	2.1		
		$V_{CC} = 5.5$ V	3.85	3.85		
V_{IL}	Low-level input voltage	$V_{CC} = 2$ V	0.5	0.5		V
		$V_{CC} = 3$ V	0.9	0.9		
		$V_{CC} = 5.5$ V	1.65	1.65		
V_I	Input voltage	0	5.5	0	5.5	V
V_O	Output voltage	0	V_{CC}	0	V_{CC}	V
I_{OH}	High-level output current	$V_{CC} = 2$ V	–50	–50		µA
		$V_{CC} = 3.3$ V ± 0.3 V	–4	–4		mA
		$V_{CC} = 5$ V ± 0.5 V	–8	–8		
I_{OL}	Low-level output current	$V_{CC} = 2$ V	50	50		µA
		$V_{CC} = 3.3$ V ± 0.3 V	4	4		mA
		$V_{CC} = 5$ V ± 0.5 V	8	8		
$\Delta t/\Delta v$	Input transition rise or fall rate	$V_{CC} = 3.3$ V ± 0.3 V	100	100		ns/V
		$V_{CC} = 5$ V ± 0.5 V	20	20		
T_A	Operating free-air temperature	–55	125	–40	85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

SN54AHC174, SN74AHC174 HEX D-TYPE FLIP-FLOPS WITH CLEAR

SCLS425E – JUNE 1998 – REVISED JANUARY 2000

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	T _A = 25°C			SN54AHC174		SN74AHC174		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V _{OH}	I _{OH} = -50 μA	2 V	1.9	2		1.9		1.9	V	
		3 V	2.9	3		2.9		2.9		
		4.5 V	4.4	4.5		4.4		4.4		
	I _{OH} = -4 mA	3 V	2.58			2.48		2.48		
	I _{OH} = -8 mA	4.5 V	3.94			3.8		3.8		
V _{OL}	I _{OL} = 50 μA	2 V			0.1		0.1	0.1	V	
		3 V			0.1		0.1	0.1		
		4.5 V			0.1		0.1	0.1		
	I _{OL} = 4 mA	3 V			0.36		0.5	0.44		
	I _{OL} = 8 mA	4.5 V			0.36		0.5	0.44		
I _I	V _I = V _{CC} or GND	0 V to 5.5 V			± 0.1		± 1*	± 1	μA	
I _{CC}	V _I = V _{CC} or GND, I _O = 0	5.5 V			4		40	40	μA	
C _i	V _I = V _{CC} or GND	5 V			1.7	10		10	pF	

* On products compliant to MIL-PRF-38535, this parameter is not production tested at V_{CC} = 0 V.

timing requirements over recommended operating free-air temperature range, V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted)

		T _A = 25°C		SN54AHC174		SN74AHC174		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
t _w	Pulse duration	CLR low	5		5		5	ns
		CLK high or low	5		5		5	
t _{su}	Setup time before CLK↑	Data	5		6		6	ns
		CLR inactive	3		3		3	
t _h	Hold time, data after CLK↑		0		0		0	ns

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V ± 0.5 V (unless otherwise noted)

		T _A = 25°C		SN54AHC174		SN74AHC174		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
t _w	Pulse duration	CLR low	5		5		5	ns
		CLK high or low	5		5		5	
t _{su}	Setup time before CLK↑	Data	4.5		4.5		4.5	ns
		CLR inactive	2.5		2.5		2.5	
t _h	Hold time, data after CLK↑		0.5		0.5		0.5	ns

PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

SN54AHC174, SN74AHC174 HEX D-TYPE FLIP-FLOPS WITH CLEAR

SCLS425E – JUNE 1998 – REVISED JANUARY 2000

switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$			SN54AHC174		SN74AHC174		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f_{max}			$C_L = 15\text{ pF}$	95*	170*		80*		80		MHz
			$C_L = 50\text{ pF}$	55	130		50		50		
t_{PHL}	$\overline{\text{CLR}}$	Any Q	$C_L = 15\text{ pF}$		4.5*	11.4*	1*	13.5*	1	13.5	ns
t_{PLH}	CLK	Any Q	$C_L = 15\text{ pF}$		5.8*	11*	1*	13*	1	13	ns
t_{PHL}					5.8*	11*	1*	13*	1	13	
t_{PHL}	$\overline{\text{CLR}}$	Any Q	$C_L = 50\text{ pF}$		6	14.9	1	17	1	17	ns
t_{PLH}	CLK	Any Q	$C_L = 50\text{ pF}$		7.5	14.5	1	16.5	1	16.5	ns
t_{PHL}					7.5	14.5	1	16.5	1	16.5	
$t_{\text{sk(o)}}$			$C_L = 50\text{ pF}$			1.5**				1.5	ns

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

** On products compliant to MIL-PRF-38535, this parameter does not apply.

switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$			SN54AHC174		SN74AHC174		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f_{max}			$C_L = 15\text{ pF}$	130*	240*		110*		110		MHz
			$C_L = 50\text{ pF}$	90	180		80		80		
t_{PHL}	$\overline{\text{CLR}}$	Any Q	$C_L = 15\text{ pF}$		3*	7.6*	1*	9*	1	9	ns
t_{PLH}	CLK	Any Q	$C_L = 15\text{ pF}$		4.1*	7.2*	1*	8.5*	1	8.5	ns
t_{PHL}					4.1*	7.2*	1*	8.5*	1	8.5	
t_{PHL}	$\overline{\text{CLR}}$	Any Q	$C_L = 50\text{ pF}$		4.2	9.6	1	11	1	11	ns
t_{PLH}	CLK	Any Q	$C_L = 50\text{ pF}$		5.5	9.2	1	10.5	1	10.5	ns
t_{PHL}					5.5	9.2	1	10.5	1	10.5	
$t_{\text{sk(o)}}$			$C_L = 50\text{ pF}$			1**				1	ns

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

** On products compliant to MIL-PRF-38535, this parameter does not apply.

operating characteristics, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	TYP	UNIT
C_{pd} Power dissipation capacitance	No load, $f = 1\text{ MHz}$	15.2	pF

PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.

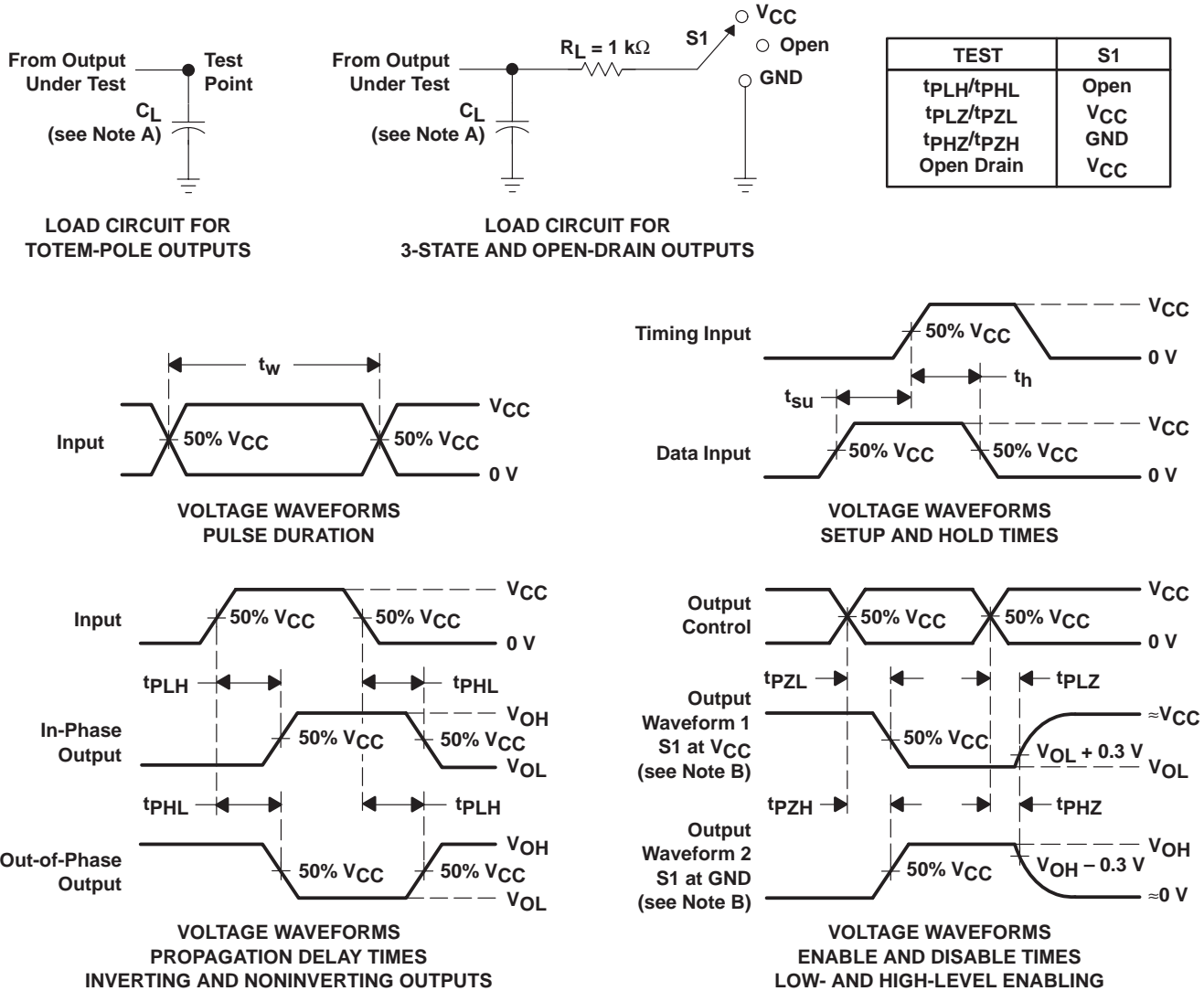


POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

SN54AHC174, SN74AHC174 HEX D-TYPE FLIP-FLOPS WITH CLEAR

SCLS425E – JUNE 1998 – REVISED JANUARY 2000

PARAMETER MEASUREMENT INFORMATION



- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 3\text{ ns}$, $t_f \leq 3\text{ ns}$.
 - D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

IMPORTANT NOTICE

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.